## **BYV74 series**

### GENERAL DESCRIPTION

Glass passivated, high efficiency rectifier diodes in a plastic envelope featuring low forward voltage drop, ultra fast reverse recovery times and soft recovery characteristic. They are intended for use in switched mode power supplies and high frequency circuits in general, where both low conduction losses and low switching losses are essential.

## **PINNING - SOT93**

PIN	DESCRIPTION
1	Anode 1 (a)
2	Cathode (k)
3	Anode 2 (a)
tab	Cathode (k)

## QUICK REFERENCE DATA

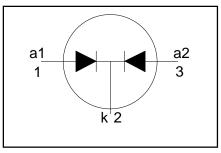
SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V <sub>RRM</sub>	BYV74- Repetitive peak reverse voltage	<b>300</b> 300	<b>400</b> 400	<b>500</b> 500	v
V <sub>F</sub> I <sub>O(AV)</sub>	Forward voltage Average output current (both diodes conducting)	1.12 30	1.12 30	1.12 30	V A
t <sub>rr</sub>	Reverse recovery time	60	60	60	ns

### PIN CONFIGURATION

()

tab

#### SYMBOL



#### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.		MAX.		UNIT
V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	Repetitive peak reverse voltage Crest working reverse voltage Continuous reverse voltage	T <sub>mb</sub> ≤ 136°C	- -	<b>-300</b> 300 300 300	<b>-400</b> 400 400 400	<b>-500</b> 500 500 500	<<<
I <sub>O(AV)</sub>	Average output current (both diodes conducting) <sup>1</sup>	square wave; $\delta = 0.5$ ; $T_{mb} \le 94 \degree C$ sinusoidal; $a = 1.57$ ; $T_{mb} \le 98 \degree C$	-		30 27		A A
I <sub>O(RMS)</sub>	RMS output current (both diodes conducting)		-		43		А
I <sub>FRM</sub>	Repetitive peak forward current per diode	t = 25 μs; δ = 0.5; T <sub>mb</sub> ≤ 94 °C	-		30		A
I <sub>FSM</sub>	Non-repetitive peak forward current per diode.	t = 10 ms t = 8.3 ms sinusoidal; with reapplied	-		150 160		A A
I²t T <sub>stg</sub> T <sub>j</sub>	I <sup>2</sup> t for fusing Storage temperature Operating junction temperature	$V_{\text{RRM(max)}}$ t = 10 ms	- -40 -		112 150 150		A <sup>2</sup> s °C °C

<sup>1</sup> Neglecting switching and reverse current losses.

For output currents in excess of 20 A, connection should be made to the exposed metal mounting base.

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## THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-hs</sub> R <sub>th j-a</sub>	heatsink	per diode both diodes conducting in free air.	- -	- - 45	2.4 1.4 -	K/W K/W K/W

#### STATIC CHARACTERISTICS

 $T_j = 25$  °C unless otherwise stated

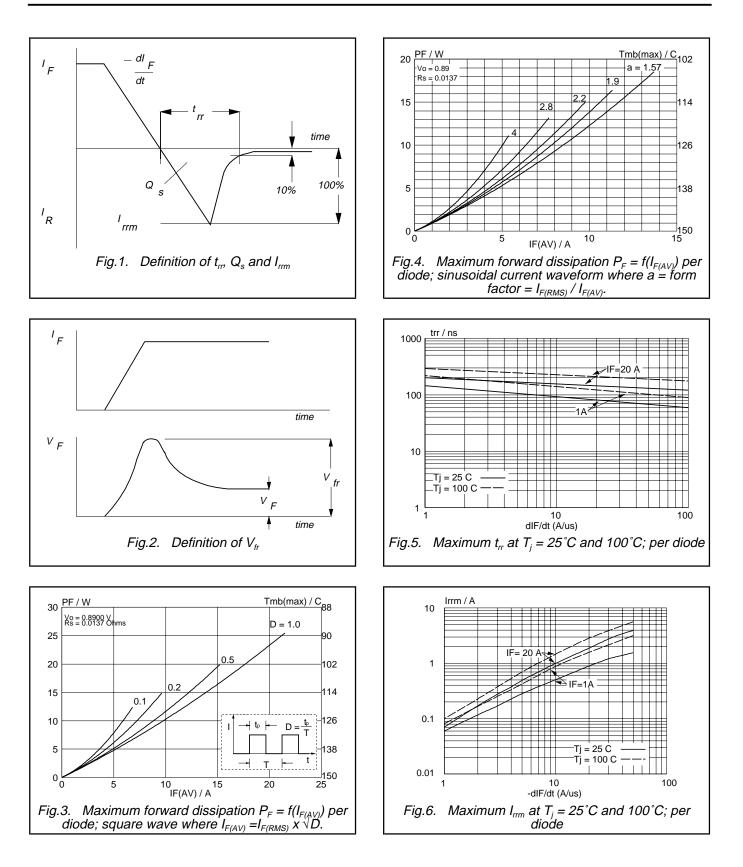
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	Forward voltage (per diode)	I <sub>F</sub> = 15 A; T <sub>j</sub> = 150°C I <sub>F</sub> = 15 A	-	0.95	1.12	V
		I <sub>F</sub> = 15 A	-	1.08	1.25	V
		$I_{\rm F} = 30  {\rm A}$	-	1.15	1.36	V
I <sub>R</sub>	Reverse current (per diode)	$\dot{V}_{R} = V_{RRM}$	-	10	50	μA
	, , , , , , , , , , , , , , , , , , ,	$V_{R} = V_{RRM}$ ; $T_{j} = 100 \text{°C}$	-	0.3	0.8	mΑ

## **DYNAMIC CHARACTERISTICS**

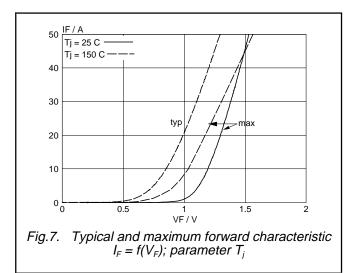
 $T_i = 25$  °C unless otherwise stated

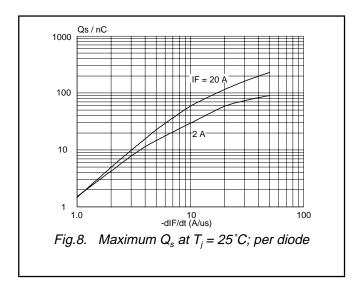
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Q <sub>s</sub>	Reverse recovery charge (per diode)	$I_F = 2 A \text{ to } V_R \ge 30 \text{ V};$ $dI_F/dt = 20 A/\mu \text{s}$	-	40	60	nC
t <sub>rr</sub>	Reverse recovery time (per diode)	$I_F = 1 \text{ A to } V_R \ge 30 \text{ V};$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	50	60	ns
l <sub>rrm</sub>	Peak reverse recovery current (per diode)	$I_{F} = 10 \text{ A to } V_{R} \ge 30 \text{ V};$ $dI_{F}/dt = 50 \text{ A}/\mu\text{s};  T_{i} = 100^{\circ}\text{C}$	-	4.2	5.2	A
V <sub>fr</sub>	Forward récovery voltage (per diode)	I <sub>F</sub> = 10 A; dI <sub>F</sub> /dt = 10 A/μs	-	2.5	-	V

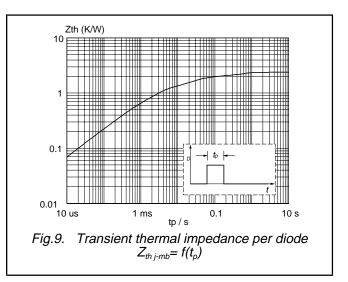
## BYV74 series



## BYV74 series

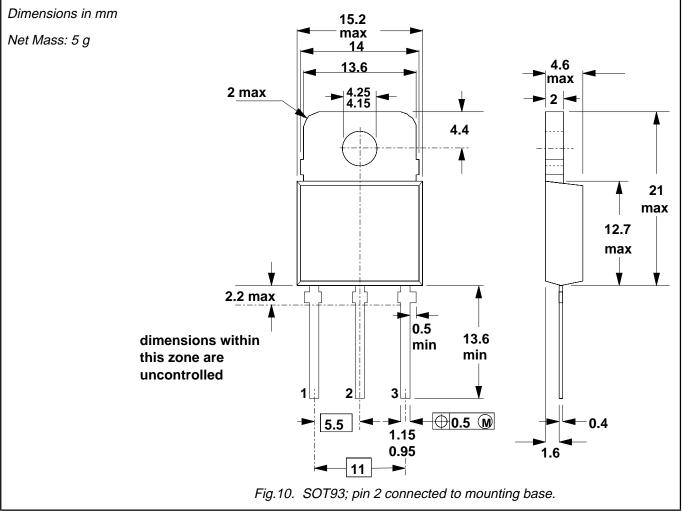






## **BYV74** series

#### **MECHANICAL DATA**



#### Notes

Refer to mounting instructions for SOT93 envelope.
Epoxy meets UL94 V0 at 1/8".

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### DEFINITIONS

Data sheet status				
Objective specification This data sheet contains target or goal specifications for product development.				
Preliminary specification	cation This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				
Application information				
Where application information is given, it is advisory and does not form part of the specification.				
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